

## SPECIFICATION AMENDMENTS

Please amend the Abstract of the Disclosure, at Page 50 of the Specification, to read as follows:

A multi-layered printed wiring board ~~is provided~~  
~~that is capable of securing required wiring density~~  
even with a decreased number of wiring layers and  
reducing radiation noises. The multi-layered printed  
wiring board has at least three wiring layers each at  
least having at least one power supply line or a ground  
line, and another kind of line, said wiring layers each  
having an outer edge. A ground line is formed at the  
outer edge of at least one of the wiring layers. A  
basic power supply line is formed inside the ground  
line. At least one power supply line extends from the  
basic power supply line. A plurality of electronic  
parts are mounted on at least one of the wiring layers.  
The at least one power supply line is wired to mounting  
positions of the electronic parts via at least one of  
the wiring layers.